5 V, 3.3 V and 2.5 V dual UART, 5 Mbit/s (max.), with 64-byte FIFOs

Rev. 04 — 17 July 2006

Product data sheet

1. General description

The SC16C752B is a dual Universal Asynchronous Receiver/Transmitter (UART) with 64-byte FIFOs, automatic hardware/software flow control, and data rates up to 5 Mbit/s (3.3 V and 5 V). The SC16C752B offers enhanced features. It has a Transmission Control Register (TCR) that stores receiver FIFO threshold levels to start/stop transmission during hardware and software flow control. With the FIFO Rdy register, the software gets the status of TXRDY/RXRDY for all four ports in one access. On-chip status registers provide the user with error indications, operational status, and modem interface control. System interrupts may be tailored to meet user requirements. An internal loopback capability allows on-board diagnostics.

The UART transmits data, sent to it over the peripheral 8-bit bus, on the TX signal and receives characters on the RX signal. Characters can be programmed to be 5 bits, 6 bits, 7 bits, or 8 bits. The UART has a 64-byte receive FIFO and transmit FIFO and can be programmed to interrupt at different trigger levels. The UART generates its own desired baud rate based upon a programmable divisor and its input clock. It can transmit even, odd, or no parity and 1, 1.5, or 2 stop bits. The receiver can detect break, idle, or framing errors, FIFO overflow, and parity errors. The transmitter can detect FIFO underflow. The UART also contains a software interface for modem control operations, and has software flow control and hardware flow control capabilities.

The SC16C752B is available in plastic LQFP48 and HVQFN32 packages.

2. Features

- Pin compatible with SC16C2550 with additional enhancements
- Up to 5 Mbit/s baud rate (at 3.3 V and 5 V; at 2.5 V maximum baud rate is 3 Mbit/s)
- 64-byte transmit FIFO
- 64-byte receive FIFO with error flags
- Programmable and selectable transmit and receive FIFO trigger levels for DMA and interrupt generation
- Software/hardware flow control
 - Programmable Xon/Xoff characters
 - Programmable auto-RTS and auto-CTS
- Optional data flow resume by Xon any character
- DMA signalling capability for both received and transmitted data
- Supports 5 V, 3.3 V and 2.5 V operation
- 5 V tolerant inputs
- Software selectable baud rate generator



- Prescaler provides additional divide-by-4 function
- Industrial temperature range (–40 °C to +85 °C)
- Pin and software compatible with SC16C752, TL16C752
- Fast data bus access time
- Programmable Sleep mode
- Programmable serial interface characteristics
 - 5-bit, 6-bit, 7-bit, or 8-bit characters
 - Even, odd, or no parity bit generation and detection
 - 1, 1.5, or 2 stop bit generation
- False start bit detection
- Complete status reporting capabilities in both normal and Sleep mode
- Line break generation and detection
- Internal test and loopback capabilities
- Fully prioritized interrupt system controls
- Modem control functions (CTS, RTS, DSR, DTR, RI, and CD)

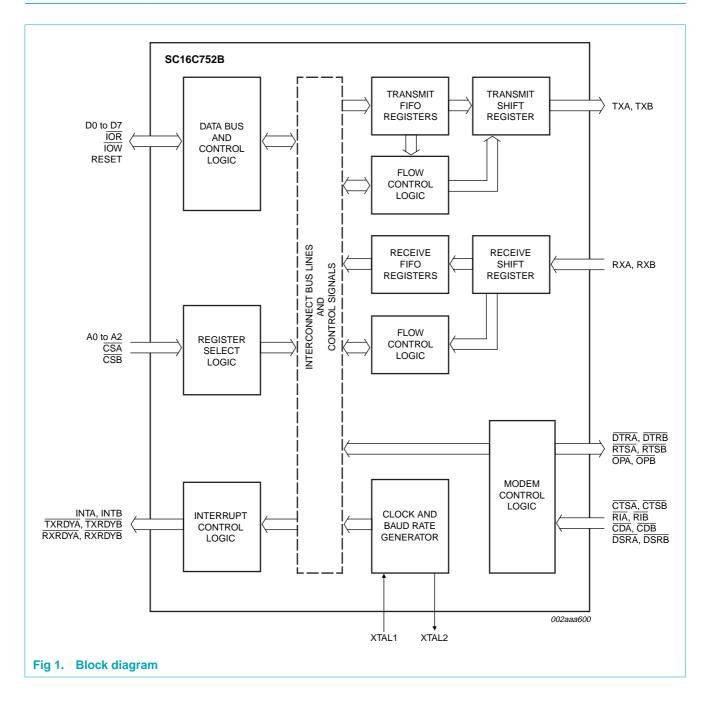
3. Ordering information

| Table 1. Ordering information | | | | | | | | |
|---------------------------------------|---------|--|----------|--|--|--|--|--|
| Type number | Package | | | | | | | |
| | Name | Description | Version | | | | | |
| SC16C752BIB48 | LQFP48 | plastic low profile quad flat package; 48 leads; body $7 \times 7 \times 1.4$ mm | SOT313-2 | | | | | |
| SC16C752BIBS | HVQFN32 | plastic thermal enhanced very thin quad flat package; no leads; 32 terminals; body $5 \times 5 \times 0.85$ mm | SOT617-1 | | | | | |

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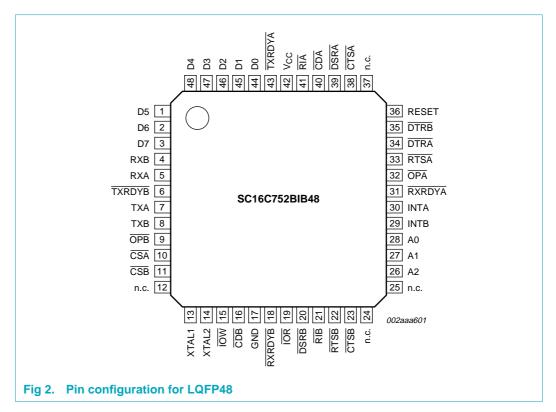
4. Block diagram

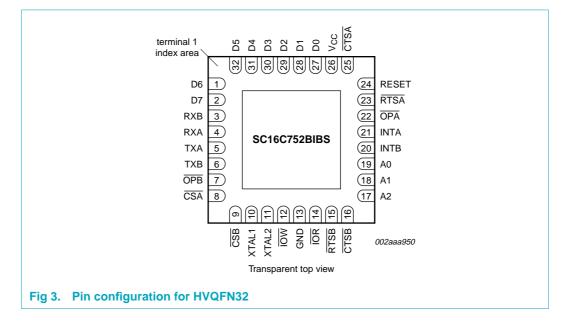


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5. Pinning information

5.1 Pinning





5.2 Pin description

| Symbol | Pin | | Туре | Description | | | |
|--------|--------|---------|------|---|--|--|--|
| - | LQFP48 | HVQFN32 | | | | | |
| A0 | 28 | 19 | I | Address 0 select bit. Internal registers address selection. | | | |
| A1 | 27 | 18 | 1 | Address 1 select bit. Internal registers address selection. | | | |
| A2 | 26 | 17 | I | Address 2 select bit. Internal registers address selection. | | | |
| CDA | 40 | - | I | Carrier Detect (active LOW). These inputs are associated with individual UAR | | | |
| CDB | 16 | - | i | channels A and B. A logic LOW on these pins indicates that a carrier has be detected by the modem for that channel. The state of these inputs is reflected the Modem Status Register (MSR). | | | |
| CSA | 10 | 8 | I | Chip Select (active LOW). These pins enable data transfers between the us CPU and the SC16C752B for the channel(s) addressed. Individual UART sections (A, B) are addressed by providing a logic LOW on the respective \overline{CS} and \overline{CSB} pins. | | | |
| CSB | 11 | 9 | I | | | | |
| CTSA | 38 | 25 | I | Clear to Send (active LOW). These inputs are associated with individual UAR | | | |
| CTSB | 23 | 16 | I | channels A and B. A logic 0 (LOW) on the $\overline{\text{CTS}}$ pins indicates the modem or data set is ready to accept transmit data from the SC16C752B. Status can be ested by reading MSR[4]. These pins only affect the transmit and receive operations when Auto- $\overline{\text{CTS}}$ function is enabled via the Enhanced Feature Register EFR[7] for hardware flow control operation. | | | |
| D0 | 44 | 27 | I/O | Data bus (bidirectional). These pins are the 8-bit, 3-state data bus for | | | |
| D1 | 45 | 28 | I/O | transferring information to or from the controlling CPU. D0 is the least significa bit and the first data bit in a transmit or receive serial data stream. | | | |
| D2 | 46 | 29 | I/O | | | | |
| D3 | 47 | 30 | I/O | | | | |
| D4 | 48 | 31 | I/O | | | | |
| D5 | 1 | 32 | I/O | | | | |
| D6 | 2 | 1 | I/O | | | | |
| D7 | 3 | 2 | I/O | | | | |
| DSRA | 39 | - | I | Data Set Ready (active LOW). These inputs are associated with individual | | | |
| DSRB | 20 | - | Ι | UART channels A and B. A logic 0 (LOW) on these pins indicates the modern data set is powered-on and is ready for data exchange with the UART. The sta of these inputs is reflected in the Modern Status Register (MSR). | | | |
| DTRA | 34 | - | 0 | Data Terminal Ready (active LOW). These outputs are associated with | | | |
| DTRB | 35 | - | 0 | individual UART channels A and B. A logic 0 (LOW) on these pins indicates th the SC16C752B is powered-on and ready. These pins can be controlled via th modem control register. Writing a logic 1 to MCR[0] will set the DTR output to logic 0 (LOW), enabling the modem. The output of these pins will be a logic 1 after writing a logic 0 to MCR[0], or after a reset. | | | |
| GND | 17 | 13 | I | Signal and power ground | | | |
| INTA | 30 | 21 | 0 | Interrupt A and B (active HIGH). These pins provide individual channel | | | |
| INTB | 29 | 20 | 0 | Interrupt A and B (active FIGH). These pins provide individual channel interrupts INTA and INTB. INTA and INTB are enabled when MCR[3] is set to logic 1, interrupt sources are enabled in the Interrupt Enable Register (IER). Interrupt conditions include: receiver errors, available receiver buffer data, available transmit buffer space, or when a modem status flag is detected. INT INTB are in the high-impedance state after reset. | | | |
| IOR | 19 | 14 | I | Input/Output Read strobe (active LOW). A HIGH-to-LOW transition on IOR will load the contents of an internal register defined by address bits A0 to A2 onto the SC16C752B data bus (D0 to D7) for access by external CPU. | | | |

| Symbol | Pin | | Туре | Description | | | |
|-----------------|-------------------|---------|------|---|--|--|--|
| | LQFP48 | HVQFN32 | | | | | |
| ĪOW | 15 | 12 | I | Input/Output Write strobe (active LOW). A LOW-to-HIGH transition on \overline{IOW} will transfer the contents of the data bus (D0 to D7) from the external CPU to an internal register that is defined by address bits A0 to A2 and \overline{CSA} and \overline{CSB} . | | | |
| n.c. | 12, 24, 25, 37 | - | - | not connected | | | |
| OPA | 32 | 22 | 0 | User defined outputs. This function is associated with individual channels A | | | |
| OPB | 9 | 7 | 0 | and B. The state of these pins is defined by the user through the software settings of MCR[3]. INTA-INTB are set to active mode and OPA-OPB to a logic 0 when MCR[3] is set to a logic 1. INTA-INTB are set to the 3-State mode and OPA-OPB to a logic 1 when MCR[3] is set to a logic 0. The output of these two pins is HIGH after reset. | | | |
| RESET | 36 | 24 | I | Reset. This pin will reset the internal registers and all the outputs. The UART transmitter output and the receiver input will be disabled during reset time. RESET is an active HIGH input. | | | |
| RIA | 41 | - | I | Ring Indicator (active LOW). These inputs are associated with individual | | | |
| RIB | 21 | - | I | UART channels, A and B. A logic 0 on these pins indicates the modem has received a ringing signal from the telephone line. A LOW-to-HIGH transition on these input pins generates a modem status interrupt, if enabled. The state of these inputs is reflected in the Modem Status Register (MSR). | | | |
| RTSA | 33 | 23 | 0 | Request to Send (active LOW). These outputs are associated with individual | | | |
| RTSB | 22 | 15 | Ο | UART channels, A and B. A logic 0 on the RTS pin indicates the transmitter has data ready and waiting to send. Writing a logic 1 in the modem control register MCR[1] will set this pin to a logic 0, indicating data is available. After a reset these pins are set to a logic 1. These pins only affect the transmit and receive operations when Auto-RTS function is enabled via the Enhanced Feature Register (EFR[6]) for hardware flow control operation. | | | |
| RXA | 5 | 4 | I | Receive data input. These inputs are associated with individual serial channe | | | |
| RXB | 4 | 3 | Ι | data to the SC16C752B. During the local Loopback mode, these RX input pins are disabled and TX data is connected to the UART RX input internally. | | | |
| RXRDYA | 31 | - | 0 | Receive Ready (active LOW). RXRDYA or RXRDYB goes LOW when the | | | |
| RXRDYB | 18 | - | 0 | trigger level has been reached or the FIFO has at least one character. It goes HIGH when the RX FIFO is empty. | | | |
| ТХА | 7 | 5 | 0 | Transmit data A, B. These outputs are associated with individual serial transmi | | | |
| ТХВ | 8 | 6 | 0 | channel data from the SC16C752B. During the local Loopback mode, the TX output pin is disabled and TX data is internally connected to the UART RX input | | | |
| TXRDYA | 43 | - | 0 | Transmit Ready (active LOW). TXRDYA or TXRDYB go LOW when there are at least a trigger level number of spaces available or when the FIFO is empty. I | | | |
| TXRDYB | 6 | - | 0 | goes HIGH when the FIFO is full or not empty. | | | |
| V _{CC} | 42 | 26 | I | Power supply input | | | |
| XTAL1 | 13 | 10 | I | Crystal or external clock input. Functions as a crystal input or as an external clock input. A crystal can be connected between XTAL1 and XTAL2 to form an internal oscillator circuit (see Figure 13). Alternatively, an external clock can be connected to this pin to provide custom data rates. | | | |
| XTAL2 | 14 | 11 | 0 | Output of the crystal oscillator or buffered clock. (See also XTAL1.) XTAL2 is used as a crystal oscillator output or a buffered clock output. | | | |
| | | | | | | | |

6. Functional description

The SC16C752B UART is pin-compatible with the SC16C2550 UART. It provides more enhanced features. All additional features are provided through a special Enhanced Feature Register (EFR).

The UART will perform serial-to-parallel conversion on data characters received from peripheral devices or modems, and parallel-to-parallel conversion on data characters transmitted by the processor. The complete status of each channel of the SC16C752B UART can be read at any time during functional operation by the processor.

The SC16C752B can be placed in an alternate mode (FIFO mode) relieving the processor of excessive software overhead by buffering received/transmitted characters. Both the receiver and transmitter FIFOs can store up to 64 bytes (including three additional bits of error status per byte for the receiver FIFO) and have selectable or programmable trigger levels. Primary outputs $\overline{\text{RXRDY}}$ and $\overline{\text{TXRDY}}$ allow signalling of DMA transfers.

The SC16C752B has selectable hardware flow control and software flow control. Hardware flow control significantly reduces software overhead and increases system efficiency by automatically controlling serial data flow using the RTS output and CTS input signals. Software flow control automatically controls data flow by using programmable Xon/Xoff characters.

The UART includes a programmable baud rate generator that can divide the timing reference clock input by a divisor between 1 and $(2^{16} - 1)$.

6.1 Trigger levels

The SC16C752B provides independent selectable and programmable trigger levels for both receiver and transmitter DMA and interrupt generation. After reset, both transmitter and receiver FIFOs are disabled and so, in effect, the trigger level is the default value of one byte. The selectable trigger levels are available via the FCR. The programmable trigger levels are available via the TLR.

6.2 Hardware flow control

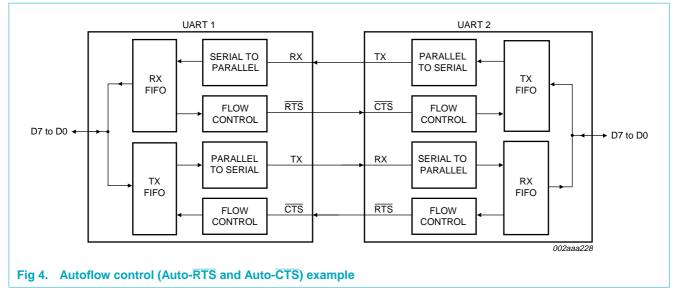
Hardware flow control is comprised of Auto-CTS and Auto-RTS. Auto-CTS and Auto-RTS can be enabled/disabled independently by programming EFR[7:6].

With Auto- $\overline{\text{CTS}}$, $\overline{\text{CTS}}$ must be active before the UART can transmit data.

Auto- $\overline{\text{RTS}}$ only activates the $\overline{\text{RTS}}$ output when there is enough room in the FIFO to receive data and de-activates the $\overline{\text{RTS}}$ output when the RX FIFO is sufficiently full. The halt and resume trigger levels in the TCR determine the levels at which $\overline{\text{RTS}}$ is activated/deactivated.

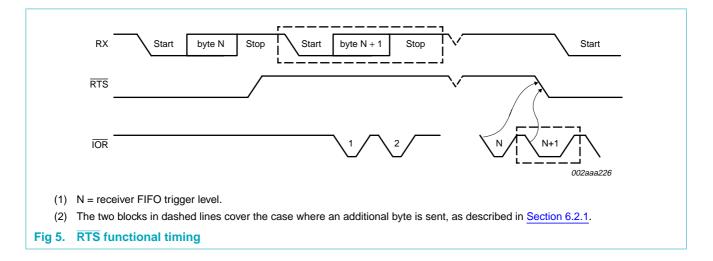
If both Auto-CTS and Auto-RTS are enabled, when RTS is connected to CTS, data transmission does not occur unless the receiver FIFO has empty space. Thus, overrun errors are eliminated during hardware flow control. If not enabled, overrun errors occur if the transmit data rate exceeds the receive FIFO servicing latency.

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6.2.1 Auto-RTS

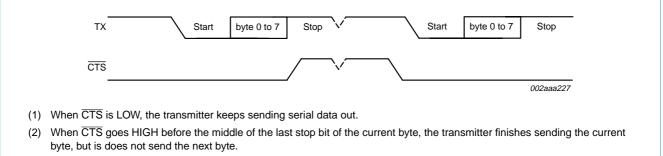
Auto-RTS data flow control originates in the receiver block (see Figure 1 "Block diagram" on page 3). Figure 5 shows RTS functional timing. The receiver FIFO trigger levels used in Auto-RTS are stored in the TCR. RTS is active if the RX FIFO level is below the halt trigger level in TCR[3:0]. When the receiver FIFO halt trigger level is reached, RTS is de-asserted. The sending device (e.g., another UART) may send an additional byte after the trigger level is reached (assuming the sending UART has another byte to send) because it may not recognize the de-assertion of RTS until it has begun sending the additional byte. RTS is automatically reasserted once the receiver FIFO reaches the resume trigger level programmed via TCR[7:4]. This re-assertion allows the sending device to resume transmission.



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6.2.2 Auto-CTS

The transmitter circuitry checks $\overline{\text{CTS}}$ before sending the next data byte. When $\overline{\text{CTS}}$ is active, the transmitter sends the next byte. To stop the transmitter from sending the following byte, $\overline{\text{CTS}}$ must be de-asserted before the middle of the last stop bit that is currently being sent. The Auto- $\overline{\text{CTS}}$ function reduces interrupts to the host system. When flow control is enabled, $\overline{\text{CTS}}$ level changes do not trigger host interrupts because the device automatically controls its own transmitter. Without Auto- $\overline{\text{CTS}}$, the transmitter sends any data present in the transmit FIFO and a receiver overrun error may result.



(3) When $\overline{\text{CTS}}$ goes from HIGH to LOW, the transmitter begins sending data again.

Fig 6. CTS functional timing

6.3 Software flow control

Software flow control is enabled through the enhanced feature register and the modem control register. Different combinations of software flow control can be enabled by setting different combinations of EFR[3:0]. Table 3 shows software flow control options.

| EFR[3] | EFR[2] | EFR[1] | EFR[0] | TX, RX software flow controls |
|--------|--------|--------|--------|--|
| 0 | 0 | Х | Х | no transmit flow control |
| 1 | 0 | Х | Х | transmit Xon1, Xoff1 |
| 0 | 1 | Х | Х | transmit Xon2, Xoff2 |
| 1 | 1 | Х | Х | transmit Xon1, Xon2, Xoff1, Xoff2 |
| Х | Х | 0 | 0 | no receive flow control |
| Х | Х | 1 | 0 | receiver compared Xon1, Xoff1 |
| Х | Х | 0 | 1 | receiver compares Xon2, Xoff2 |
| 1 | 0 | 1 | 1 | transmit Xon1, Xoff1 |
| | | | | receiver compares Xon1 and Xon2, Xoff1 and Xoff2 |
| 0 | 1 | 1 | 1 | transmit Xon2, Xoff2 |
| | | | | receiver compares Xon1 and Xon2, Xoff1 and Xoff2 |
| 1 | 1 | 1 | 1 | transmit Xon1, Xon2, Xoff1, Xoff2 |
| | | | | receiver compares Xon1 and Xon2, Xoff1 and Xoff2 |

Table 3. Software flow control options (EFR[0:3])

There are two other enhanced features relating to software flow control:

- Xon Any function (MCR[5]): Operation will resume after receiving any character after recognizing the Xoff character. It is possible that an Xon1 character is recognized as an Xon Any character, which could cause an Xon2 character to be written to the RX FIFO.
- **Special character (EFR[5]):** Incoming data is compared to Xoff2. Detection of the special character sets the Xoff interrupt (IIR[4]) but does not halt transmission. The Xoff interrupt is cleared by a read of the IIR. The special character is transferred to the RX FIFO.

6.3.1 RX

When software flow control operation is enabled, the SC16C752B will compare incoming data with Xoff1/Xoff2 programmed characters (in certain cases, Xoff1 and Xoff2 must be received sequentially). When the correct Xoff character are received, transmission is halted after completing transmission of the current character. Xoff detection also sets IIR[4] (if enabled via IER[5]) and causes INT to go HIGH.

To resume transmission, an Xon1/Xon2 character must be received (in certain cases Xon1 and Xon2 must be received sequentially). When the correct Xon characters are received, IIR[4] is cleared, and the Xoff interrupt disappears.

6.3.2 TX

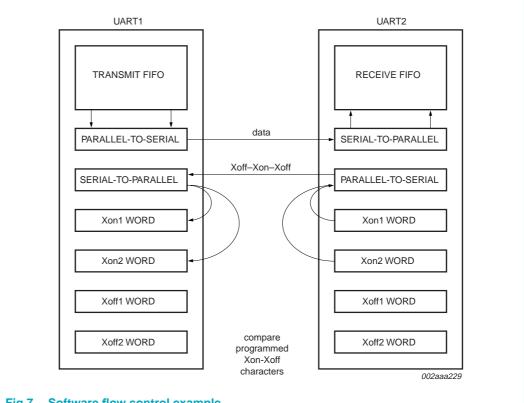
Xoff1/Xoff2 character is transmitted when the RX FIFO has passed the **halt** trigger level programmed in TCR[3:0].

Xon1/Xon2 character is transmitted when the RX FIFO reaches the **resume** trigger level programmed in TCR[7:4].

The transmission of Xoff/Xon(s) follows the exact same protocol as transmission of an ordinary byte from the FIFO. This means that even if the word length is set to be 5, 6, or 7 characters, then the 5, 6, or 7 least significant bits of Xoff1/Xoff2, Xon1/Xoff2 will be transmitted. (Note that the transmission of 5 bits, 6 bits, or 7 bits of a character is seldom done, but this functionality is included to maintain compatibility with earlier designs.)

It is assumed that software flow control and hardware flow control will never be enabled simultaneously. Figure 7 shows an example of software flow control.

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6.3.3 Software flow control example

Fig 7. Software flow control example

6.3.3.1 Assumptions

UART1 is transmitting a large text file to UART2. Both UARTs are using software flow control with single character Xoff (0Fh) and Xon (0Dh) tokens. Both have Xoff threshold (TCR[3:0] = Fh) set to 60, and Xon threshold (TCR[7:4] = 8h) set to 32. Both have the interrupt receive threshold (TLR[7:4] = Dh) set to 52.

UART 1 begins transmission and sends 52 characters, at which point UART2 will generate an interrupt to its processor to service the RCV FIFO, but assume the interrupt latency is fairly long. UART1 will continue sending characters until a total of 60 characters have been sent. At this time, UART2 will transmit a 0Fh to UART1, informing UART1 to halt transmission. UART1 will likely send the 61st character while UART2 is sending the Xoff character. Now UART2 is serviced and the processor reads enough data out of the RX FIFO that the level drops to 32. UART2 will now send a 0Dh to UART1, informing UART1 to resume transmission.

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6.4 Reset

Table 4 summarizes the state of register after reset.

Table 4. Register reset functions^[1]

| Register | Reset control | Reset state |
|-----------------------------------|---------------|--|
| Interrupt Enable Register | RESET | all bits cleared |
| Interrupt Identification Register | RESET | bit 0 is set; all other bits cleared |
| FIFO Control Register | RESET | all bits cleared |
| Line Control Register | RESET | reset to 0001 1101 (1Dh) |
| Modem Control Register | RESET | all bits cleared |
| Line Status Register | RESET | bit 5 and bit 6 set; all other bits cleared |
| Modem Status Register | RESET | bits [3:0] cleared; bits [7:4] input signals |
| Enhanced Feature Register | RESET | all bits cleared |
| Receiver Holding Register | RESET | pointer logic cleared |
| Transmitter Holding Register | RESET | pointer logic cleared |
| Transmission Control Register | RESET | all bits cleared |
| Trigger Level Register | RESET | all bits cleared |
| | | |

[1] Registers DLL, DLM, SPR, XON1, XON2, XOFF1, XOFF2 are not reset by the top-level reset signal RESET, i.e., they hold their initialization values during reset.

Table 5 summarizes the state of registers after reset.

Table 5.Signal RESET functions

| Signal | Reset control | Reset state |
|--------|---------------|-------------|
| ТХ | RESET | HIGH |
| RTS | RESET | HIGH |
| DTR | RESET | HIGH |
| RXRDY | RESET | HIGH |
| TXRDY | RESET | LOW |

6.5 Interrupts

The SC16C752B has interrupt generation and prioritization (six prioritized levels of interrupts) capability. The Interrupt Enable Register (IER) enables each of the six types of interrupts and the INT signal in response to an interrupt generation. The IER can also disable the interrupt system by clearing bit 0 to bit 3 and bit 5 to bit 7. When an interrupt is generated, the IIR indicates that an interrupt is pending and provides the type of interrupt through IIR[5:0]. Table 6 summarizes the interrupt control functions.

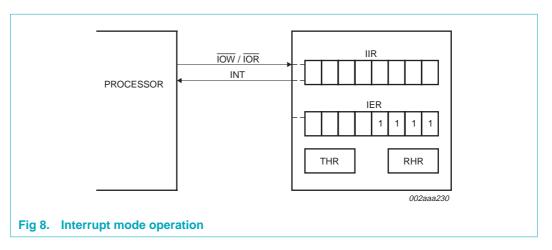
| Table 6. | Interrupt c | ontrol functions | | |
|----------|-------------------|----------------------|--|---|
| IIR[5:0] | Priority level | Interrupt type | Interrupt source | Interrupt reset method |
| 00 0001 | None | none | none | none |
| 00 0110 | 1 | receiver line status | OE, FE, PE, or BI errors occur in characters in the RX FIFO | FE, PE, BI: all erroneous characters are read from the RX FIFO. |
| | | | | OE: read LSR |
| 00 1100 | 2 | RX time-out | stale data in RX FIFO | read RHR |
| 00 0100 | 2 | RHR interrupt | DRDY (data ready) (FIFO disable) RX FIFO above trigger level (FIFO enable) | read RHR |
| 00 0010 | 3 | THR interrupt | TFE (THR empty) (FIFO disable) TX FIFO passes above trigger level (FIFO enable) | read IIR or a write to the THR |
| 00 0000 | 4 | modem status | MSR[3:0] = 0 | read MSR |
| 01 0000 | 5 | Xoff interrupt | receive Xoff character(s)/special character | receive Xon character(s)/Read of IIR |
| 10 0000 | 6 | CTS, RTS | $\overline{\text{RTS}}$ pin or $\overline{\text{CTS}}$ pin change state from active (LOW) to inactive (HIGH) | read IIR |

It is important to note that for the framing error, parity error, and break conditions, LSR[7] generates the interrupt. LSR[7] is set when there is an error anywhere in the RX FIFO, and is cleared only when there are no more errors remaining in the FIFO. LSR[4:2] always represent the error status for the received character at the top of the RX FIFO. Reading the RX FIFO updates LSR[4:2] to the appropriate status for the new character at the top of the FIFO. If the RX FIFO is empty, then LSR[4:2] are all zeros.

For the Xoff interrupt, if an Xoff flow character detection caused the interrupt, the interrupt is cleared by an Xon flow character detection. If a special character detection caused the interrupt, the interrupt is cleared by a read of the LSR.

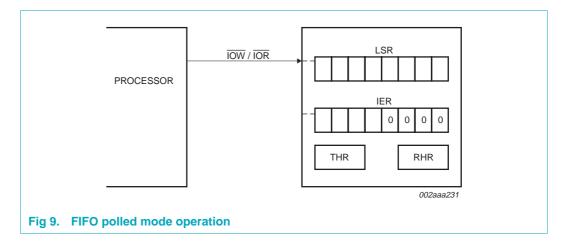
6.5.1 Interrupt mode operation

In interrupt mode (if any bit of IER[3:0] is 1) the processor is informed of the status of the receiver and transmitter by an interrupt signal, INT. Therefore, it is not necessary to continuously poll the line status register (LSR) to see if any interrupt needs to be serviced. Figure 8 shows interrupt mode operation.



6.5.2 Polled mode operation

In polled mode (IER[3:0] = 0000) the status of the receiver and transmitter can be checked by polling the Line Status Register (LSR). This mode is an alternative to the FIFO interrupt mode of operation where the status of the receiver and transmitter is automatically known by means of interrupts sent to the CPU. Figure 9 shows FIFO polled mode operation.



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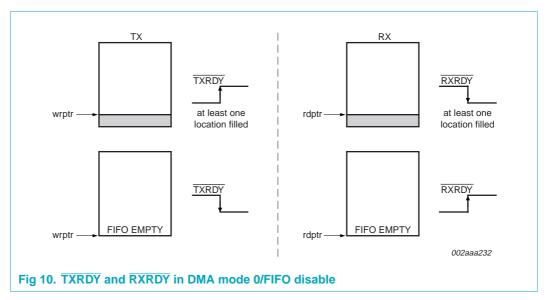
6.6 DMA operation

There are two modes of DMA operation, DMA mode 0 or DMA mode 1, selected by FCR[3].

In DMA mode 0 or FIFO disable (FCR[0] = 0) DMA occurs in single character transfers. In DMA mode 1, multi-character (or block) DMA transfers are managed to relieve the processor for longer periods of time.

6.6.1 Single DMA transfers (DMA mode 0/FIFO disable)

Figure 10 shows TXRDY and RXRDY in DMA mode 0/FIFO disable.



6.6.1.1 Transmitter

When empty, the TXRDY signal becomes active. TXRDY will go inactive after one character has been loaded into it.

6.6.1.2 Receiver

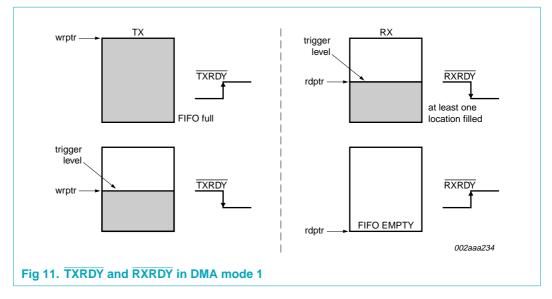
RXRDY is active when there is at least one character in the FIFO. It becomes inactive when the receiver is empty.

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6.6.2 Block DMA transfers (DMA mode 1)

Figure 11 shows $\overline{\text{TXRDY}}$ and $\overline{\text{RXRDY}}$ in DMA mode 1.



6.6.2.1 Transmitter

TXRDY is active when there is a trigger level number of spaces available. It becomes inactive when the FIFO is full.

6.6.2.2 Receiver

RXRDY becomes active when the trigger level has been reached, or when a time-out interrupt occurs. It will go inactive when the FIFO is empty or an error in the RX FIFO is flagged by LSR[7].

6.7 Sleep mode

Sleep mode is an enhanced feature of the SC16C752B UART. It is enabled when EFR[4], the enhanced functions bit, is set **and** when IER[4] is set. Sleep mode is entered when:

- The serial data input line, RX, is idle (see <u>Section 6.8 "Break and time-out</u> conditions").
- The TX FIFO and TX shift register are empty.
- There are no interrupts pending except THR and time-out interrupts.

Remark: Sleep mode will not be entered if there is data in the RX FIFO.

In Sleep mode, the UART clock and baud rate clock are stopped. Since most registers are clocked using these clocks, the power consumption is greatly reduced. The UART will wake up when any change is detected on the RX line, when there is any change in the state of the modem input pins, or if data is written to the TX FIFO.

Remark: Writing to the divisor latches DLL and DLM to set the baud clock must not be done during Sleep mode. Therefore, it is advisable to disable Sleep mode using IER[4] before writing to DLL or DLM.

6.8 Break and time-out conditions

An RX idle condition is detected when the receiver line, RX, has been HIGH for 4 character time. The receiver line is sampled midway through each bit.

When a break condition occurs, the TX line is pulled LOW. A break condition is activated by setting LCR[6].

6.9 Programmable baud rate generator

The SC16C752B UART contains a programmable baud generator that takes any clock input and divides it by a divisor in the range between 1 and $(2^{16} - 1)$. An additional divide-by-4 prescaler is also available and can be selected by MCR[7], as shown in Figure 12. The output frequency of the baud rate generator is $16 \times$ the baud rate. The formula for the divisor is:

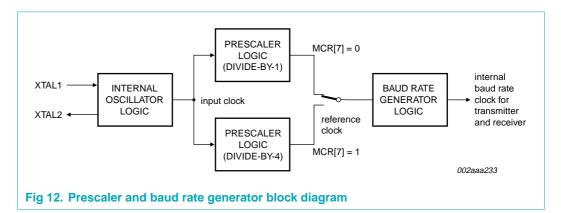
$$divisor = \frac{\left(\frac{XTAL1 \ crystal \ input \ frequency}{prescaler}\right)}{(desired \ baud \ rate \times 16)}$$

Where:

prescaler = 1, when MCR[7] is set to 0 after reset (divide-by-1 clock selected) prescaler = 4, when MCR[7] is set to 1 after reset (divide-by-4 clock selected).

Remark: The default value of prescaler after reset is divide-by-1.

Figure 12 shows the internal prescaler and baud rate generator circuitry.



DLL and DLM must be written to in order to program the baud rate. DLL and DLM are the least significant and most significant byte of the baud rate divisor. If DLL and DLM are both zero, the UART is effectively disabled, as no baud clock will be generated.

Remark: The programmable baud rate generator is provided to select both the transmit and receive clock rates.

<u>Table 7</u> and <u>Table 8</u> show the baud rate and divisor correlation for crystal with frequency 1.8432 MHz and 3.072 MHz, respectively.

Figure 13 shows the crystal clock circuit reference.

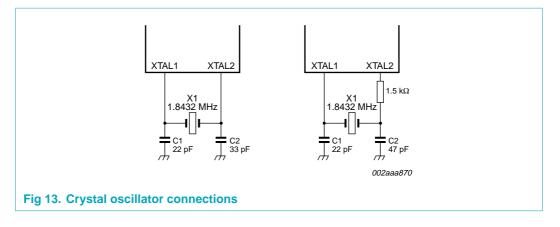
5 V, 3.3 V and 2.5 V dual UART, 5 Mbit/s (max.), with 64-byte FIFOs

| Desired baud rate | Divisor used to generate 16× clock | Percent error difference between desired and actual |
|-------------------|---------------------------------------|--|
| 50 | 2304 | |
| 75 | 1536 | |
| 110 | 1047 | 0.026 |
| 134.5 | 857 | 0.058 |
| 150 | 768 | |
| 300 | 384 | |
| 600 | 192 | |
| 1200 | 96 | |
| 1800 | 64 | |
| 2000 | 58 | 0.69 |
| 2400 | 48 | |
| 3600 | 32 | |
| 4800 | 24 | |
| 7200 | 16 | |
| 9600 | 12 | |
| 19200 | 6 | |
| 38400 | 3 | |
| 56000 | 2 | 2.86 |

Table 7. Baud rates using a 1.8432 MHz crystal

Table 8.Baud rates using a 3.072 MHz crystal

| Desired baud rate | Divisor used to generate 16× clock | Percent error difference between desired and actual |
|-------------------|---------------------------------------|--|
| 50 | 2304 | |
| 75 | 2560 | |
| 110 | 1745 | 0.026 |
| 134.5 | 1428 | 0.034 |
| 150 | 1280 | |
| 300 | 640 | |
| 600 | 320 | |
| 1200 | 160 | |
| 1800 | 107 | 0.312 |
| 2000 | 96 | |
| 2400 | 80 | |
| 3600 | 53 | 0.628 |
| 4800 | 40 | |
| 7200 | 27 | 1.23 |
| 9600 | 20 | |
| 19200 | 10 | |
| 38400 | 5 | |



7. Register descriptions

Each register is selected using address lines A0, A1, A2, and in some cases, bits from other registers. The programming combinations for register selection are shown in Table 9.

Table 9. Register map - read/write properties

| | | | ter inch i territor historia | |
|----|----|----|---|---|
| A2 | A1 | A0 | Read mode | Write mode |
| 0 | 0 | 0 | Receive Holding Register (RHR) | Transmit Holding Register (THR) |
| 0 | 0 | 1 | Interrupt Enable Register (IER) | Interrupt Enable Register |
| 0 | 1 | 0 | Interrupt Identification Register (IIR) | FIFO Control Register (FCR) |
| 0 | 1 | 1 | Line Control Register (LCR) | Line Control Register |
| 1 | 0 | 0 | Modem Control Register (MCR)[1] | Modem Control Register ^[1] |
| 1 | 0 | 1 | Line Status Register (LSR) | |
| 1 | 1 | 0 | Modem Status Register (MSR) | |
| 1 | 1 | 1 | Scratchpad Register (SPR) | Scratchpad Register |
| 0 | 0 | 0 | Divisor Latch LSB (DLL) ^{[2][3]} | Divisor Latch LSB ^{[2][3]} |
| 0 | 0 | 1 | Divisor Latch MSB (DLM)[2][3] | Divisor Latch MSB ^{[2][3]} |
| 0 | 1 | 0 | Enhanced Feature Register (EFR)[2][4] | Enhanced Feature Register ^{[2][4]} |
| 1 | 0 | 0 | Xon1 word ^{[2][4]} | Xon1 word[2][4] |
| 1 | 0 | 1 | Xon2 word ^{[2][4]} | Xon2 word ^{[2][4]} |
| 1 | 1 | 0 | Xoff1 word ^{[2][4]} | Xoff1 word ^{[2][4]} |
| 1 | 1 | 1 | Xoff2 word ^{[2][4]} | Xoff2 word ^{[2][4]} |
| 1 | 1 | 0 | Transmission Control Register (TCR)[2][5] | Transmission Control Register ^{[2][5]} |
| 1 | 1 | 1 | Trigger Level Register (TLR)[2][5] | Trigger Level Register ^{[2][5]} |
| 1 | 1 | 1 | FIFO ready register ^{[2][6]} | |

[1] MCR[7] can only be modified when EFR[4] is set.

[2] Accessed by a combination of address pins and register bits.

[3] Accessible only when LCR[7] is logic 1.

- [4] Accessible only when LCR is set to 1011 1111 (BFh).
- [5] Accessible only when EFR[4] = 1 and MCR[6] = 1, i.e., EFR[4] and MCR[6] are read/write enables.
- [6] Accessible only when \overline{CSA} or $\overline{CSB} = 0$, MCR[2] = 1, and loopback is disabled (MCR[4] = 0).

5 V, 3.3 V and 2.5 V dual UART, 5 Mbit/s (max.), with 64-byte FIFOs

Table 10 lists and describes the SC16C752B internal registers.

| A2 | A 1 | A0 | Register | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Read/ Write |
|-----|------------|------|---------------------|---|---|--|--|--------------------------------------|--------------------------------------|--------------------------------------|--------------------------------------|----------------|
| Ger | neral | Reg | gister Set <u>[</u> | 1] | | | | | | | | |
| 0 | 0 | 0 | RHR | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | R |
|) | 0 | 0 | THR | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | W |
|) | 0 | 1 | IER | 0/CTS interrupt enable ^[2] | 0/RTS interrupt enable ^[2] | 0/Xoff ^[2] | 0/X sleep mode ^[2] | modem status interrupt | receive line status interrupt | THR empty interrupt | Rx data available interrupt | R/W |
| C | 1 | 0 | FCR | RX trigger level (MSB) | RX trigger level (LSB) | 0/TX trigger level (MSB) ^[2] | 0/TX trigger level (LSB) ^[2] | DMA mode select | TX FIFO reset | RX FIFO reset | FIFO enable | W |
| D | 1 | 0 | IIR | FCR[0] | FCR[0] | 0/CTS, RTS | 0/Xoff | interrupt priority bit 2 | interrupt priority bit 1 | interrupt priority bit 0 | interrupt status | R |
| C | 1 | 1 | LCR | DLAB | break control bit | set parity | parity type select | parity enable | number of stop bits | word length bit 1 | word length bit 0 | R/W |
| 1 | 0 | 0 | MCR | 1× or 1×/4 clock ^[2] | TCR and TLR enable ^[2] | 0/Xon Any <mark>[2]</mark> | 0/enable loopback | IRQ enable OP | FIFO ready enable | RTS | DTR | R/W |
| 1 | 0 | 1 | LSR | 0/error in RX FIFO | THR and TSR empty | THR empty | break interrupt | framing error | parity error | overrun error | data in receiver | R |
| 1 | 1 | 0 | MSR | CD | RI | DSR | CTS | ΔCD | ΔRI | ΔDSR | ∆CTS | R |
| | 1 | 1 | SPR | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | R/W |
| | 1 | 0 | TCR | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | R/W |
| | 1 | 1 | TLR | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | R/W |
| | 1 | 1 | FIFO Rdy | 0 | 0 | RX FIFO B status | RX FIFO A status | 0 | 0 | TX FIFO B status | TX FIFO A status | R |
| Spe | ecial | Reg | ister Set[3 | <u>8]</u> | | | | | | | | |
|) | 0 | 0 | DLL | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | R/W |
|) | 0 | 1 | DLM | bit 15 | bit 14 | bit 13 | bit 12 | bit 11 | bit 10 | bit 9 | bit 8 | R/W |
| Enł | nanc | ed F | Register Se | et <u>[4]</u> | | | | | | | | |
|) | 1 | 0 | EFR | Auto CTS | Auto RTS | Special character detect | Enable IER[7:4], FCR[5:4], MCR[7:5] | software flow control bit 3 | software flow control bit 2 | software flow control bit 1 | software flow control bit 0 | R/W |
| l | 0 | 0 | Xon1 | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | R/W |
| | 0 | 1 | Xon2 | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | R/W |
| l | 1 | 0 | Xoff1 | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | R/W |
| 1 | 1 | 1 | Xoff2 | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | R/W |

Table 10. SC16C752B internal registers

[1] These registers are accessible only when LCR[7] = 0.

[2] These bits can only be modified if register bit EFR[4] is enabled, i.e., if enhanced functions are enabled.

[3] The Special Register set is accessible only when LCR[7] is set to a logic 1.

[4] Enhanced Feature Register; Xon1/Xon2 and Xoff1/Xoff2 are accessible only when LCR is set to BFh.

Remark: Refer to the notes under Table 9 for more register access information.

7.1 Receiver Holding Register (RHR)

The receiver section consists of the Receiver Holding Register (RHR) and the Receiver Shift Register (RSR). The RHR is actually a 64-byte FIFO. The RSR receives serial data from the RX terminal. The data is converted to parallel data and moved to the RHR. The receiver section is controlled by the Line Control Register. If the FIFO is disabled, location zero of the FIFO is used to store the characters.

Remark: In this case, characters are overwritten if overflow occurs.

If overflow occurs, characters are lost. The RHR also stores the error status bits associated with each character.

7.2 Transmit Holding Register (THR)

The transmitter section consists of the Transmit Holding Register (THR) and the Transmit Shift Register (TSR). The THR is actually a 64-byte FIFO. The THR receives data and shifts it into the TSR, where it is converted to serial data and moved out on the TX terminal. If the FIFO is disabled, the FIFO is still used to store the byte. Characters are lost if overflow occurs.

7.3 FIFO Control Register (FCR)

This is a write-only register that is used for enabling the FIFOs, clearing the FIFOs, setting transmitter and receiver trigger levels, and selecting the type of DMA signalling. <u>Table 11</u> shows FIFO control register bit settings.

| Bit | Symbol | Description |
|-----|----------------------------------|---|
| 7:6 | FCR[7] (MSB), FCR[6] (LSB) | RCVR trigger. Sets the trigger level for the RX FIFO. 00 - 8 characters 01 - 16 characters 10 - 56 characters 11 - 60 characters |
| 5:4 | FCR[5] (MSB), FCR[4] (LSB) | TX trigger. Sets the trigger level for the TX FIFO. 00 - 8 spaces 01 - 16 spaces 10 - 32 spaces 11 - 56 spaces FCR[5:4] can only be modified and enabled when EFR[4] is set. This is because the transmit trigger level is regarded as an enhanced function. |
| 3 | FCR[3] | DMA mode select. logic 0 = set DMA mode '0' logic 1 = set DMA mode '1' |
| 2 | FCR[2] | Reset TX FIFO. logic 0 = no FIFO transmit reset (normal default condition) logic 1 = Clears the contents of the transmit FIFO and resets the FIFO counter logic (the transmit shift register is not cleared or altered). This bit will return to a logic 0 after clearing the FIFO. |
| 1 | FCR[1] | Reset RX FIFO. logic 0 = no FIFO receive reset (normal default condition) logic 1 = Clears the contents of the receive FIFO and resets the FIFO counter logic (the receive shift register is not cleared or altered). This bit will return to a logic 0 after clearing the FIFO. |
| 0 | FCR[0] | FIFO enable.logic 0 = disable the transmit and receive FIFO (normal default condition)logic 1 = enable the transmit and receive FIFO. |

7.4 Line Control Register (LCR)

This register controls the data communication format. The word length, number of stop bits, and parity type are selected by writing the appropriate bits to the LCR. <u>Table 12</u> shows the Line Control Register bit settings.

Table 12. Line Control Register bits description

| Bit | Symbol | Description |
|-----|----------|--|
| 7 | LCR[7] | Divisor latch enable. |
| | | logic 0 = divisor latch disabled (normal default condition) |
| | | logic 1 = divisor latch enabled |
| 6 | LCR[6] | Break control bit. When enabled, the Break control bit causes a break condition to be transmitted (the TX output is forced to a logic 0 state). This condition exists until disabled by setting LCR[6] to a logic 0. |
| | | logic 0 = no TX break condition (normal default condition) |
| | | logic 1 = forces the transmitter output (TX) to a logic 0 to alert the communication terminal to a line break condition |
| 5 | LCR[5] | Set parity. LCR[5] selects the forced parity format (if LCR[3] = 1). |
| | | logic 0 = parity is not forced (normal default condition) |
| | | LCR[5] = logic 1 and LCR[4] = logic 0: parity bit is forced to a logical 1 for the transmit and receive data. |
| | | LCR[5] = logic 1 and LCR[4] = logic 1: parity bit is forced to a logical 0 for the transmit and receive data. |
| 4 | LCR[4] | Parity type select. |
| | | logic 0 = odd parity is generated (if LCR[3] = 1) |
| | | logic 1 = even parity is generated (if LCR[3] = 1) |
| 3 | LCR[3] | Parity enable. |
| | | logic 0 = no parity (normal default condition) |
| | | logic 1 = a parity bit is generated during transmission and the receiver checks for received parity |
| 2 | LCR[2] | Number of Stop bits. Specifies the number of stop bits. |
| | | 0 - 1 stop bit (word length = 5, 6, 7, 8) |
| | | 1 - 1.5 stop bits (word length = 5) |
| | | 1 = 2 stop bits (word length = 6, 7, 8) |
| 1:0 | LCR[1:0] | Word length bits 1, 0. These two bits specify the word length to be transmitted or received. |
| | | 00 - 5 bits |
| | | 01 - 6 bits |
| | | 10 - 7 bits |
| | | 11 - 8 bits |

7.5 Line Status Register (LSR)

Table 13 shows the Line Status Register bit settings.

| Table | 13. Line § | Status Register bits description | | | | | |
|-------|------------|---|--|--|--|--|--|
| Bit | Symbol | Description | | | | | |
| 7 | LSR[7] | FIFO data error. | | | | | |
| | | logic 0 = no error (normal default condition) | | | | | |
| | | logic 1 = At least one parity error, framing error, or break indication is in the receiver FIFO. This bit is cleared when no more errors are present in the FIFO. | | | | | |
| 6 | LSR[6] | THR and TSR empty. This bit is the Transmit Empty indicator. | | | | | |
| | | logic 0 = transmitter hold and shift registers are not empty | | | | | |
| | | logic 1 = transmitter hold and shift registers are empty | | | | | |
| 5 | LSR[5] | THR empty. This bit is the Transmit Holding Register Empty indicator. | | | | | |
| | | logic 0 = Transmit Holding Register is not empty | | | | | |
| | | logic 1 = Transmit Holding Register is empty. The processor can now load up to 64 bytes of data into the THR if the TX FIFO is enabled. | | | | | |
| 4 | LSR[4] | Break interrupt. | | | | | |
| | | logic 0 = No break condition (normal default condition) | | | | | |
| | | logic 1 = A break condition occurred and associated byte is 00, i.e., RX was LOW for one character time frame | | | | | |
| 3 | LSR[3] | Framing error. | | | | | |
| | | logic 0 = no framing error in data being read from RX FIFO (normal default condition) | | | | | |
| | | logic 1 = framing error occurred in data being read from RX FIFO, i.e., received data did not have a valid stop bit. | | | | | |
| 2 | LSR[2] | Parity error. | | | | | |
| | | logic 0 = no parity error (normal default condition) | | | | | |
| | | logic 1 = parity error in data being read from RX FIFO | | | | | |
| 1 | LSR[1] | Overrun error. | | | | | |
| | | logic 0 = no overrun error (normal default condition) | | | | | |
| | | logic 1 = overrun error has occurred | | | | | |
| 0 | LSR[0] | Data in receiver. | | | | | |
| | | logic 0 = no data in receive FIFO (normal default condition) | | | | | |
| | | logic 1 = at least one character in the RX FIFO | | | | | |

When the LSR is read, LSR[4:2] reflect the error bits (BI, FE, PE) of the character at the top of the RX FIFO (next character to be read). The LSR[4:2] registers do not physically exist, as the data read from the RX FIFO is output directly onto the output data bus, DI[4:2], when the LSR is read. Therefore, errors in a character are identified by reading the LSR and then reading the RHR.

LSR[7] is set when there is an error anywhere in the RX FIFO, and is cleared only when there are no more errors remaining in the FIFO.

Reading the LSR does not cause an increment of the RX FIFO read pointer. The RX FIFO read pointer is incremented by reading the RHR.

Remark: The three error bits (parity, framing, break) may not be updated correctly in the first read of the LSR when the input clock (XTAL1) is running faster than 36 MHz. However, the second read is always correct. It is strongly recommended that when using this device with a clock faster than 36 MHz, that the LSR be read twice and only the second read be used for decision making. All other bits in the LSR are correct on all reads.

7.6 Modem Control Register (MCR)

The MCR controls the interface with the mode, data set, or peripheral device that is emulating the modem. Table 14 shows modem control register bit settings.

Table 14. Modem Control Register bits description

| Bit | Symbol | Description |
|-----|-----------|---|
| 7 | MCR[7][1] | Clock select. |
| | | logic 0 = divide-by-1 clock input |
| | | logic 1 = divide-by-4 clock input |
| 6 | MCR[6][1] | TCR and TLR enable. |
| | | logic 0 = no action |
| | | logic 1 = enable access to the TCR and TLR registers |
| 5 | MCR[5][1] | Xon Any. |
| | | logic 0 = disable Xon Any function |
| | | logic 1 = enable Xon Any function |
| 4 | MCR[4] | Enable loopback. |
| | | logic 0 = normal operating mode. |
| | | logic 1 = enable local Loopback mode (internal). In this mode the MCR[3:0] signals are looped back into MSR[7:4] and the TX output is looped back to the RX input internally. |
| 3 | MCR[3] | IRQ enable OP. |
| | | logic 0 = forces INTA, INTB outputs to the 3-state mode and OP output to HIGH state |
| | | logic 1 = forces the INTA-INTB outputs to the active state and OP output to LOW state. In Loopback mode, controls MSR[7]. |
| 2 | MCR[2] | FIFO Ready enable. |
| | | logic 0 = disable the FIFO Rdy register |
| | | logic 1 = enable the FIFO Rdy register. In Loopback mode, controls MSR[6]. |
| 1 | MCR[1] | RTS |
| | | logic 0 = force \overline{RTS} output to inactive (HIGH) |
| | | logic 1 =force $\overline{\text{RTS}}$ output to active (LOW). In loopback mode, controls MSR[4]. If Auto- $\overline{\text{RTS}}$ is enabled, the $\overline{\text{RTS}}$ output is controlled by hardware flow control. |
| 0 | MCR[0] | DTR |
| | | logic 0 = force $\overline{\text{DTR}}$ output to inactive (HIGH) |
| | | logic 1 = force $\overline{\text{DTR}}$ output to active (LOW). In Loopback mode, controls MSR[5]. |
| | | |

[1] MCR[7:5] can only be modified when EFR[4] is set, i.e., EFR[4] is a write enable.

7.7 Modem Status Register (MSR)

This 8-bit register provides information about the current state of the control lines from the mode, data set, or peripheral device to the processor. It also indicates when a control input from the modem changes state. <u>Table 15</u> shows Modem Status Register bit settings per channel.

Table 15. Modem Status Register bits description

| Bit | Symbol | Description |
|-----|--------|---|
| 7 | MSR[7] | CD (active HIGH, logical 1) ^[1] . This bit is the complement of the \overline{CD} input during normal mode. During internal Loopback mode, it is equivalent to MCR[3]. |
| 6 | MSR[6] | RI (active HIGH, logical 1) ^[1] . This bit is the complement of the \overline{RI} input during normal mode. During internal Loopback mode, it is equivalent to MCR[2]. |
| 5 | MSR[5] | DSR (active HIGH, logical 1) ^[1] . This bit is the complement of the DSR input during normal mode. During Internal Loopback mode, it is equivalent MCR[0]. |
| 4 | MSR[4] | CTS (active HIGH, logical 1) ^[1] . This bit is the complement of the CTS input during normal mode. During internal Loopback mode, it is equivalent to MCR[1]. |
| 3 | MSR[3] | Δ CD. Indicates that $\overline{\text{CD}}$ input (or MCR[3] in Loopback mode) has changed state. Cleared on a read. |
| 2 | MSR[2] | Δ RI. Indicates that $\overline{\text{RI}}$ input (or MCR[2] in Loopback mode) has changed state from LOW to HIGH. Cleared on a read. |
| 1 | MSR[1] | Δ DSR. Indicates that $\overline{\text{DSR}}$ input (or MCR[0] in Loopback mode) has changed state. Cleared on a read. |
| 0 | MSR[0] | $\Delta \text{CTS}.$ Indicates that CTS input (or MCR[1] in Loopback mode) has changed state. Cleared on a read. |

[1] The primary inputs RI, CD, CTS, DSR are all active LOW, but their registered equivalents in the MSR and MCR (in Loopback) registers are active HIGH.

7.8 Interrupt Enable Register (IER)

The Interrupt Enable Register (IER) enables each of the six types of interrupt, receiver error, RHR interrupt, THR interrupt, Xoff received, or CTS/RTS change of state from LOW to HIGH. The INT output signal is activated in response to interrupt generation. <u>Table 16</u> shows Interrupt Enable Register bit settings.

Table 16. Interrupt Enable Register bits description

| Bit | Symbol | Description |
|-----|--------------------|---|
| 7 | IER[7] [1] | $\overline{\text{CTS}}$ interrupt enable. logic 0 = disable the $\overline{\text{CTS}}$ interrupt (normal default condition) logic 1 = enable the $\overline{\text{CTS}}$ interrupt |
| 6 | IER[6] [<u>1]</u> | $\overline{\text{RTS}}$ interrupt enable. logic 0 = disable the $\overline{\text{RTS}}$ interrupt (normal default condition) logic 1 = enable the $\overline{\text{RTS}}$ interrupt |
| 5 | IER[5] [<u>1]</u> | Xoff interrupt. logic 0 = disable the Xoff interrupt (normal default condition) logic 1 = enable the Xoff interrupt |
| 4 | IER[4] [<u>1]</u> | Sleep mode. logic 0 = disable Sleep mode (normal default condition) logic 1 = enable Sleep mode. See <u>Section 6.7 "Sleep mode"</u> for details. |
| 3 | IER[3] | Modem Status Interrupt. logic 0 = disable the Modem Status Register interrupt (normal default condition) logic 1 = enable the Modem Status Register interrupt |
| 2 | IER[2] | Receive Line Status interrupt. logic 0 = disable the receiver line status interrupt (normal default condition) logic 1 = enable the receiver line status interrupt |
| 1 | IER[1] | Transmit Holding Register interrupt. logic 0 = disable the THR interrupt (normal default condition) logic 1 = enable the THR interrupt |
| 0 | IER[0] | Receive Holding Register interrupt. logic 0 = disable the RHR interrupt (normal default condition) logic 1 = enable the RHR interrupt |

[1] IER[7:4] can only be modified if EFR[4] is set, i.e., EFR[4] is a write enable. Re-enabling IER[1] will not cause a new interrupt if the THR is below the threshold.

7.9 Interrupt Identification Register (IIR)

The IIR is a read-only 8-bit register which provides the source of the interrupt in a prioritized manner. Table 17 shows Interrupt Identification Register bit settings.

| Table 17. | Interrupt | Identification | Register | bits | description |
|-----------|-----------|----------------|----------|------|-------------|
| | | | | | |

| Bit | Symbol | Description | | | |
|-----|----------|---|--|--|--|
| 7:6 | IIR[7:6] | Mirror the contents of FCR[0] | | | |
| 5 | IIR[5] | RTS/CTS LOW-to-HIGH change of state | | | |
| 4 | IIR[4] | 1 = Xoff/Special character has been detected | | | |
| 3:1 | IIR[3:1] | 3-bit encoded interrupt. See Table 18. | | | |
| 0 | IIR[0] | Interrupt status. logic 0 = an interrupt is pending logic 1 = no interrupt is pending | | | |

The interrupt priority list is shown in <u>Table 18</u>.

Table 18. Interrupt priority list

| | interio | pr priori | iy nat | | | | |
|-------------------|---------|-----------|--------|--------|--------|--------|--|
| Priority level | lir[5] | IIR[4] | IIR[3] | IIR[2] | IIR[1] | IIR[0] | Source of the interrupt |
| 1 | 0 | 0 | 0 | 1 | 1 | 0 | Receiver Line Status error |
| 2 | 0 | 0 | 1 | 1 | 0 | 0 | Receiver time-out interrupt |
| 2 | 0 | 0 | 0 | 1 | 0 | 0 | RHR interrupt |
| 3 | 0 | 0 | 0 | 0 | 1 | 0 | THR interrupt |
| 4 | 0 | 0 | 0 | 0 | 0 | 0 | Modem interrupt |
| 5 | 0 | 1 | 0 | 0 | 0 | 0 | Received Xoff signal/ special character |
| 6 | 1 | 0 | 0 | 0 | 0 | 0 | $\overline{\text{CTS}}$, $\overline{\text{RTS}}$ change of state from active (LOW) to inactive (HIGH) |
| | | | | | | | |

7.10 Enhanced Feature Register (EFR)

This 8-bit register enables or disables the enhanced features of the UART. <u>Table 19</u> shows the Enhanced Feature Register bit settings.

Table 19. Enhanced Feature Register bits description

| Bit | Symbol | Description | | |
|-----|--------|---|--|--|
| 7 | EFR[7] | CTS flow control enable. | | |
| | | logic 0 = $\overline{\text{CTS}}$ flow control is disabled (normal default condition) | | |
| | | logic 1 = $\overline{\text{CTS}}$ flow control is enabled. Transmission will stop when a HIGH signal is detected on the $\overline{\text{CTS}}$ pin. | | |
| 6 | EFR[6] | $\overline{\text{RTS}}$ flow control enable. logic 0 = $\overline{\text{RTS}}$ flow control is disabled (normal default condition) logic 1 = $\overline{\text{RTS}}$ flow control is enabled. The $\overline{\text{RTS}}$ pin goes HIGH when the receiver FIFO halt trigger level TCR[3:0] is reached, and goes LOW when the receiver FIFO resume transmission trigger level TCR[7:4] is reached. | | |

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 Table 19.
 Enhanced Feature Register bits description ...continued

| Bit | Symbol | Description |
|-----|----------|--|
| 5 | EFR[5] | Special character detect. |
| | | logic 0 = special character detect disabled (normal default condition) |
| | | logic 1 = special character detect enabled. Received data is compared with Xoff2 data. If a match occurs, the received data is transferred to FIFO and IIR[4] is set to a logical 1 to indicate a special character has been detected. |
| 4 | EFR[4] | Enhanced functions enable bit. |
| | | logic 0 = disables enhanced functions and writing to IER[7:4], FCR[5:4], MCR[7:5] |
| | | logic 1 = enables the enhanced function IER[7:4], FCR[5:4], and MCR[7:5] can be modified, i.e., this bit is therefore a write enable. |
| 3:0 | EFR[3:0] | Combinations of software flow control can be selected by programming these bits. See <u>Table 3 "Software flow control options (EFR[0:3])"</u> . |

7.11 Divisor latches (DLL, DLM)

These are two 8-bit registers which store the 16-bit divisor for generation of the baud clock in the baud rate generator. DLM stores the most significant part of the divisor. DLL stores the least significant part of the divisor.

Note that DLL and DLM can only be written to before Sleep mode is enabled, i.e., before IER[4] is set.

7.12 Transmission Control Register (TCR)

This 8-bit register is used to store the RX FIFO threshold levels to stop/start transmission during hardware/software flow control. <u>Table 20</u> shows Transmission Control Register bit settings.

| Bit | Symbol | Description |
|-----|----------|---|
| 7:4 | TCR[7:4] | RX FIFO trigger level to resume transmission (0 to 60). |
| 3:0 | TCR[3:0] | RX FIFO trigger level to halt transmission (0 to 60). |

TCR trigger levels are available from 0 bytes to 60 bytes with a granularity of four.

Remark: TCR can only be written to when EFR[4] = 1 and MCR[6] = 1. The programmer must program the TCR such that TCR[3:0] > TCR[7:4]. There is no built-in hardware check to make sure this condition is met. Also, the TCR must be programmed with this condition before Auto- \overline{RTS} or software flow control is enabled to avoid spurious operation of the device.

7.13 Trigger Level Register (TLR)

This 8-bit register is pulsed to store the transmit and received FIFO trigger levels used for DMA and interrupt generation. Trigger levels from 4 to 60 can be programmed with a granularity of 4. Table 21 shows trigger level register bit settings.

| Table 21. | Trigger | Level | Register | bits | description |
|-----------|---------|-------|----------|------|-------------|
|-----------|---------|-------|----------|------|-------------|

| Bit | Symbol | Description |
|-----|----------|--|
| 7:4 | TLR[7:4] | RX FIFO trigger levels (4 to 60), number of characters available |
| 3:0 | TLR[3:0] | TX FIFO trigger levels (4 to 60), number of spaces available |

Remark: TLR can only be written to when EFR[4] = 1 and MCR[6] = 1. If TLR[3:0] or TLR[7:4] are logical 0, the selectable trigger levels via the FIFO Control Register (FCR) are used for the transmit and receive FIFO trigger levels. Trigger levels from 4 bytes to 60 bytes are available with a granularity of four. The TLR should be programmed for N_{4} , where N is the desired trigger level.

When the trigger level setting in TLR is zero, the SC16C752B uses the trigger level setting defined in FCR. If TLR has non-zero trigger level value, the trigger level defined in FCR is discarded. This applies to both transmit FIFO and receive FIFO trigger level setting.

When TLR is used for RX trigger level control, FCR[7:6] should be left at the default state, i.e., '00'.

7.14 FIFO ready register

The FIFO ready register provides real-time status of the transmit and receive FIFOs of both channels.

| Bit | Symbol | Description |
|-----|---------------|-----------------------------------|
| 7:6 | FIFO Rdy[7:6] | unused; always 0 |
| 5 | FIFO Rdy[5] | RX FIFO B status. Related to DMA. |
| 4 | FIFO Rdy[4] | RX FIFO A status. Related to DMA. |
| 3:2 | FIFO Rdy[3:2] | unused; always 0 |
| 1 | FIFO Rdy[1] | TX FIFO B status. Related to DMA. |
| 0 | FIFO Rdy[0] | TX FIFO A status. Related to DMA. |

Table 22. FIFO Ready Register bits description

The FIFO Rdy register is a read-only register that can be accessed when any of the two UARTs is selected \overline{CSA} or $\overline{CSB} = 0$, MCR[2] (FIFO Rdy Enable) is a logic 1, and loopback is disabled. The address is 111.

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8. Programmer's guide

The base set of registers that is used during high-speed data transfer have a straightforward access method. The extended function registers require special access bits to be decoded along with the address lines. The following guide will help with programming these registers. Note that the descriptions below are for individual register access. Some streamlining through interleaving can be obtained when programming all the registers.

| Table 23. Register programming guide | , |
|---|--|
| Command | Actions |
| Set baud rate to VALUE1, VALUE2 | Read LCR (03), save in temp Set LCR (03) to 80 Set DLL (00) to VALUE1 SET DLM (01) to VALUE2 Set LCR (03) to temp |
| Set Xoff1, Xon1 to VALUE1, VALUE2 | Read LCR (03), save in temp Set LCR (03) to BF Set Xoff1 (06) to VALUE1 SET Xon1 (04) to VALUE2 Set LCR (03) to temp |
| Set Xoff2, Xon2 to VALUE1, VALUE2 | Read LCR (03), save in temp Set LCR (03) to BF Set Xoff2 (07) to VALUE1 SET Xon2 (05) to VALUE2 Set LCR (03) to temp |
| Set software flow control mode to VALUE | Read LCR (03), save in temp Set LCR (03) to BF Set EFR (02) to VALUE Set LCR (03) to temp |
| Set flow control threshold to VALUE | Read LCR (03), save in temp1 Set LCR (03) to BF Read EFR (02), save in temp2 Set EFR (02) to 10 + temp2 Set LCR (03) to 00 Read MCR (04), save in temp3 Set MCR (04) to 40 + temp3 Set TCR (06) to VALUE Set MCR (04) to temp3 Set LCR (03) to BF Set EFR (02) to temp2 Set LCR (03) to temp1 |

Table 23. Register programming guide

5 V, 3.3 V and 2.5 V dual UART, 5 Mbit/s (max.), with 64-byte FIFOs

| Command | Actions |
|---|--|
| Set TX FIFO and RX FIFO thresholds to VALUE | Read LCR (03), save in temp1 Set LCR (03) to BF |
| | Read EFR (02), save in temp2 |
| | Set EFR (02) to 10 + temp2 |
| | Set LCR (03) to 00 |
| | Read MCR (04), save in temp3 |
| | Set MCR (04) to 40 + temp3 |
| | Set TLR (07) to VALUE |
| | Set MCR (04) to temp3 |
| | Set LCR (03) to BF |
| | Set EFR (02) to temp2 |
| | Set LCR (03) to temp1 |
| Read FIFO Rdy register | Read MCR (04), save in temp1 |
| | Set temp2 = temp1 × $EF^{[1]}$ |
| | Set MCR (04) = 40 + temp2 |
| | Read FFR (07), save in temp2 |
| | Pass temp2 back to host |
| | Set MCR (04) to temp1 |
| Set prescaler value to divide-by-1 | Read LCR (03), save in temp1 |
| | Set LCR (03) to BF |
| | Read EFR (02), save in temp2 |
| | Set EFR (02) to 10 + temp2 |
| | Set LCR (03) to 00 |
| | Read MCR (04), save in temp3 |
| | Set MCR (04) to temp $3 \times 7F^{[1]}$ |
| | Set LCR (03) to BF |
| | Set EFR (02) to temp2 |
| | Set LCR (03) to temp1 |
| Set prescaler value to divide-by-4 | Read LCR (03), save in temp1 |
| | Set LCR (03) to BF |
| | Read EFR (02), save in temp2 |
| | Set EFR (02) to 10 + temp2 |
| | Set LCR (03) to 00 |
| | Read MCR (04), save in temp3 |
| | Set MCR (04) to temp3 + 80 |
| | Set LCR (03) to BF |
| | Set EFR (02) to temp2 |
| | Set LCR (03) to temp1 |

Table 23. Register programming guide ...continued

[1] \times sign here means bit-AND.

9. Limiting values

Table 24. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|---------------------|-----------------------|------|-----------------------|------|
| V _{CC} | supply voltage | | - | 7 | V |
| VI | input voltage | | -0.3 | V _{CC} + 0.3 | V |
| Vo | output voltage | | -0.3 | V _{CC} + 0.3 | V |
| T _{amb} | ambient temperature | operating in free-air | -40 | +85 | °C |
| T _{stg} | storage temperature | | -65 | +150 | °C |

10. Static characteristics

Table 25. Static characteristics

 V_{CC} = 2.5 V, 3.3 V ± 10 % or 5 V ± 10 %.

| Symbol | Parameter | Conditions | | 2.5 V | | 3.3 V and 5 V | | | Unit | |
|------------------------|-------------------------------------|---------------------------|------------|------------------------|-----------------|------------------------|------------------------|-----------------|------------------------|----|
| | | | | Min | Тур | Max | Min | Тур | Max | _ |
| V _{CC} | supply voltage | | | V _{CC} – 10 % | V _{CC} | V _{CC} + 10 % | V _{CC} – 10 % | V _{CC} | V _{CC} + 10 % | V |
| VI | input voltage | | | 0 | - | V _{CC} | 0 | - | V _{CC} | V |
| V _{IH} | HIGH-level input voltage | | <u>[1]</u> | 1.6 | - | V _{CC} | 2.0 | - | V _{CC} | V |
| VIL | LOW-level input voltage | | <u>[1]</u> | - | - | 0.65 | - | - | 0.8 | V |
| Vo | output voltage | | [2] | 0 | - | V _{CC} | 0 | - | V _{CC} | V |
| V _{OH} | HIGH-level | $I_{OH} = -8 \text{ mA}$ | [3] | - | - | - | 2.0 | - | - | V |
| | output voltage | $I_{OH} = -4 \text{ mA}$ | [4] | - | - | - | 2.0 | - | - | V |
| | | $I_{OH} = -800 \ \mu A$ | [3] | 1.85 | - | - | - | - | - | V |
| | | $I_{OH} = -400 \ \mu A$ | [4] | 1.85 | - | - | - | - | - | V |
| V _{OL} | LOW-level output | $I_{OL} = 8 \text{ mA}$ | [3] | - | - | - | - | - | 0.4 | V |
| | voltage ^[5] | $I_{OL} = 4 \text{ mA}$ | [4] | - | - | - | - | - | 0.4 | V |
| | | $I_{OL} = 2 \text{ mA}$ | [3] | - | - | 0.4 | - | - | - | V |
| | | $I_{OL} = 1.6 \text{ mA}$ | [4] | - | - | 0.4 | - | - | - | V |
| Ci | input capacitance | | | - | - | 18 | - | - | 18 | pF |
| T _{amb} | operating ambient temperature | | | -40 | 25 | 85 | -40 | 25 | 85 | °C |
| Tj | junction temperature | | <u>[6]</u> | 0 | 25 | 125 | 0 | 25 | 125 | °C |
| δ | clock duty cycle | | | - | 50 | - | - | 50 | - | % |
| I _{CC} | supply current | f = 5 MHz | [7] | - | - | 3.5 | - | - | 4.5 | mA |
| I _{CC(sleep)} | Sleep mode supply current | | [8] | - | - | 50 | - | - | 50 | μA |

[1] Meets TTL levels, $V_{IO(min)} = 2 V$ and $V_{IH(max)} = 0.8 V$ on non-hysteresis inputs.

[2] Applies for external output buffers.

[3] These parameters apply for D7 to D0.

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- [4] These parameters apply for DTRA, DTRB, INTA, INTB, RTSA, RTSB, RXRDYA, RXRDYB, TXRDYA, TXRDYB, TXA, TXB.
- [5] Except x_2 , $V_{OL} = 1$ V typical.
- [6] These junction temperatures reflect simulated conditions. Absolute maximum junction temperature is 150 °C. The customer is responsible for verifying junction temperature.
- [7] Measurement condition, normal operation other than Sleep mode: V_{CC} = 3.3 V; T_{amb} = 25 °C. Full duplex serial activity on all two serial (UART) channels at the clock frequency specified in the recommended operating conditions with divisor of 1.
- [8] Sleep mode current might be higher if there is activity on the UART data bus during Sleep mode.

11. Dynamic characteristics

Table 26. Dynamic characteristics

 T_{amb} = -40 °C to +85 °C; V_{CC} = 2.5 V, 3.3 V ± 10 % or 5 V ± 10 %, unless specified otherwise.

| Symbol | Parameter | Conditions | onditions 2.5 V | | 3.3 | V and 5 V | d 5 V Unit | |
|-----------------------|---|------------|-----------------|-------------------------|-----|-------------------------|------------|--|
| | | | Min | Max | Min | Max | | |
| t _{d1} | IOR delay from chip select | | 10 | - | 0 | - | ns | |
| t _{d2} | read cycle delay | 25 pF load | 20 | - | 20 | - | ns | |
| t _{d3} | delay from IOR to data | 25 pF load | - | 77 | - | 26 | ns | |
| t _{d4} | data disable time | 25 pF load | - | 15 | - | 15 | ns | |
| t _{d5} | IOW delay from chip select | | 10 | - | 10 | - | ns | |
| t _{d6} | write cycle delay | | 25 | - | 25 | - | ns | |
| t _{d7} | delay from IOW to output | 25 pF load | - | 100 | - | 33 | ns | |
| t _{d8} | delay to set interrupt from modem input | 25 pF load | - | 100 | - | 24 | ns | |
| t _{d9} | delay to reset interrupt from \overline{IOR} | 25 pF load | - | 100 | - | 24 | ns | |
| t _{d10} | delay from stop to set interrupt | | - | 1T _{RCLK} [2] | - | 1T _{RCLK} [2] | S | |
| t _{d11} | delay from \overline{IOR} to reset interrupt | 25 pF load | - | 100 | - | 29 | ns | |
| t _{d12} | delay from start to set interrupt | | - | 100 | - | 100 | ns | |
| t _{d13} | delay from $\overline{\text{IOW}}$ to transmit start | | 8 | 24T _{RCLK} [2] | 8 | 24T _{RCLK} [2] | S | |
| t _{d14} | delay from $\overline{\text{IOW}}$ to reset interrupt | | - | 100 | - | 70 | ns | |
| t _{d15} | delay from stop to set RXRDY | | - | 1T _{RCLK} [2] | - | 1T _{RCLK} [2] | S | |
| t _{d16} | delay from IOR to reset RXRDY | | - | 100 | - | 75 | ns | |
| t _{d17} | delay from IOW to set TXRDY | | - | 100 | - | 70 | ns | |
| t _{d18} | delay from start to reset TXRDY | | - | 16T _{RCLK} [2] | - | 16T _{RCLK} [2] | S | |
| t _{d19} | delay between successive assertion of IOW and IOR | | - | 20 | - | 20 | ns | |
| t _{h1} | chip select hold time from IOR | | 0 | - | 0 | - | ns | |
| t _{h2} | chip select hold time from $\overline{\text{IOW}}$ | | 0 | - | 0 | - | ns | |
| t _{h3} | data hold time | | 15 | - | 15 | - | ns | |
| t _{h4} | address hold time | | 0 | - | 0 | - | ns | |
| t _{h5} | hold time from XTAL1 clock HIGH-to-LOW transition to $\overline{\text{IOW}}$ or $\overline{\text{IOR}}$ release | | 20 | - | 20 | - | ns | |
| t _{p1} | clock cycle period | | 10 | - | 6 | - | ns | |
| t _{p2} | clock cycle period | | 10 | - | 6 | - | ns | |
| f _{XTAL1} | frequency on pin XTAL1 | [1] | - | 48 | - | 80 | MHz | |
| t _{w(RESET)} | pulse width on pin RESET | [3] | 100 | - | 40 | - | ns | |
| | | | | | | | | |

| Symbol | Parameter | Conditions | 2 | 2.5 V | | 3.3 V and 5 V | |
|------------------|--|------------|-----|-------|-----|---------------|----|
| | | | Min | Max | Min | Max | |
| t _{su1} | address se-up time | | 0 | - | 0 | - | ns |
| t _{su2} | data setup time | | 16 | - | 16 | - | ns |
| t _{su3} | setup time from IOW or IOR assertion to XTAL1 clock LOW-to-HIGH transition | | 20 | - | 20 | - | ns |
| t _{w1} | IOR strobe width | | 77 | - | 30 | - | ns |
| t _{w2} | IOW strobe width | | 30 | - | 30 | - | ns |

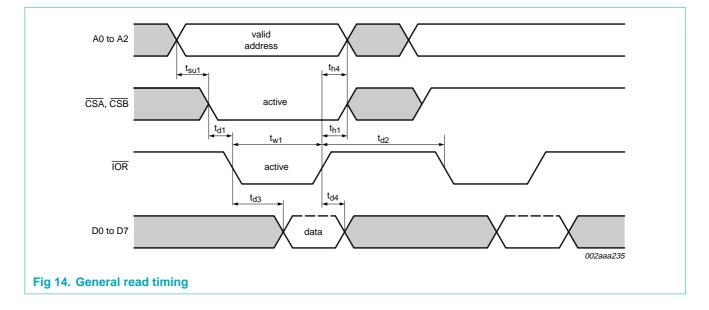
Table 26. Dynamic characteristics ...continued

[1] Applies to external clock; crystal oscillator max 24 MHz.

RCLK is an internal signal derived from Divisor Latch LSB (DLL) and Divisior Latch MSB (DLM) divisior latches. [2]

Reset pulse must happen when CSA, CSB, IOR, IOW are inactive. [3]

11.1 Timing diagrams



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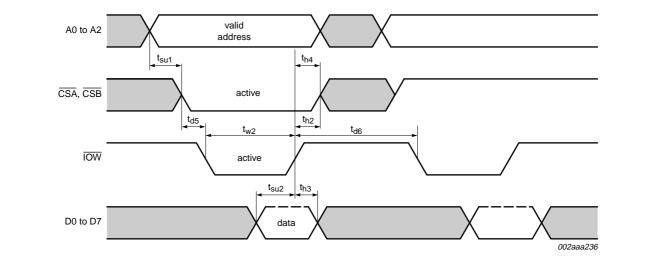
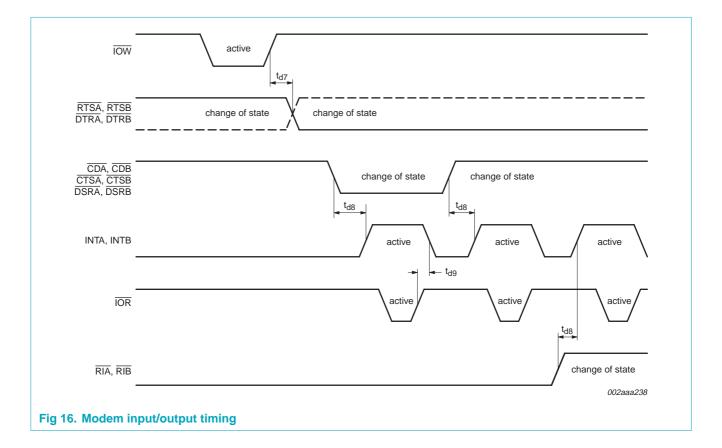
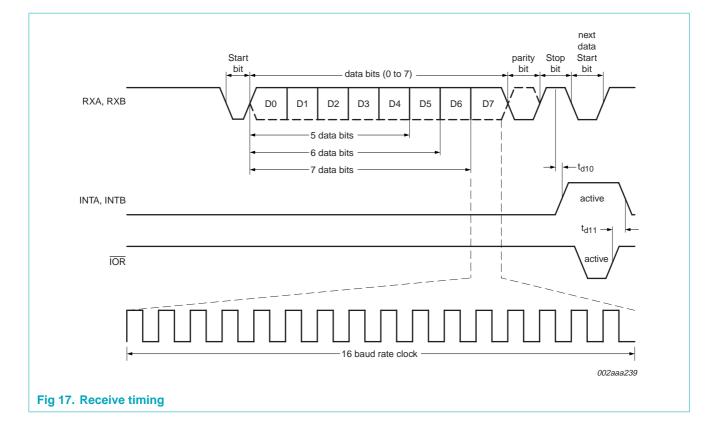
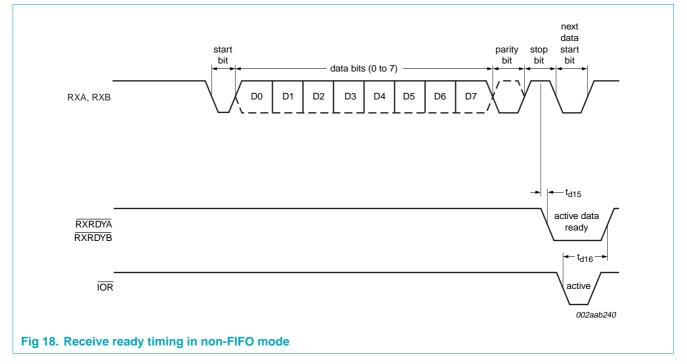


Fig 15. General write timing

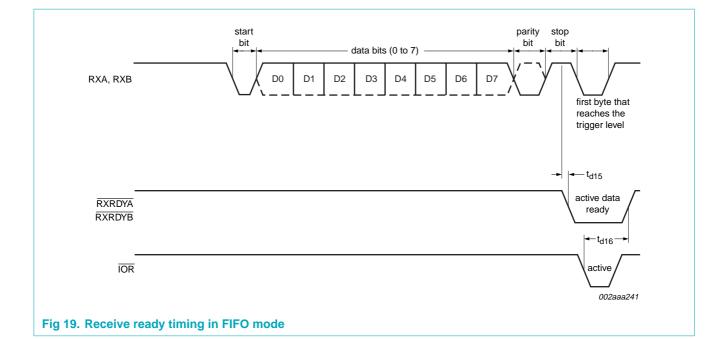


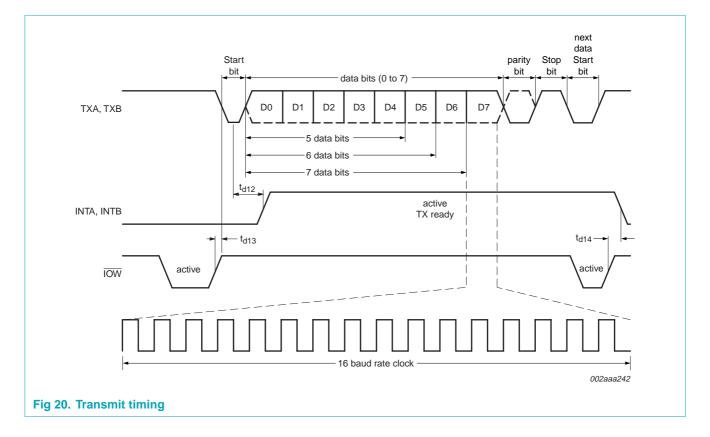
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5 V, 3.3 V and 2.5 V dual UART, 5 Mbit/s (max.), with 64-byte FIFOs





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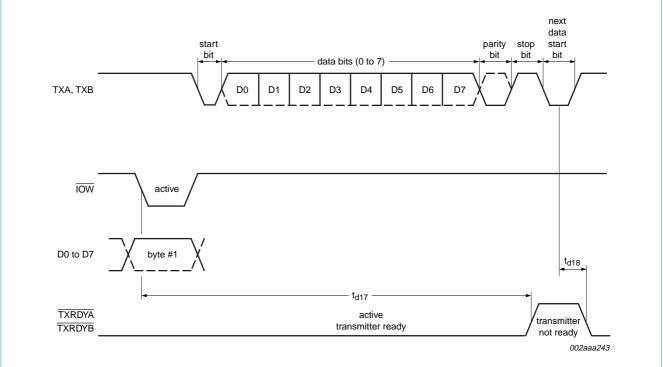
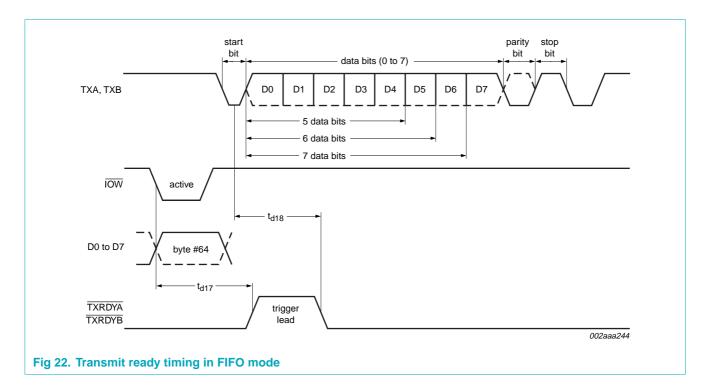


Fig 21. Transmit ready timing in non-FIFO mode



5 V, 3.3 V and 2.5 V dual UART, 5 Mbit/s (max.), with 64-byte FIFOs

12. Package outline

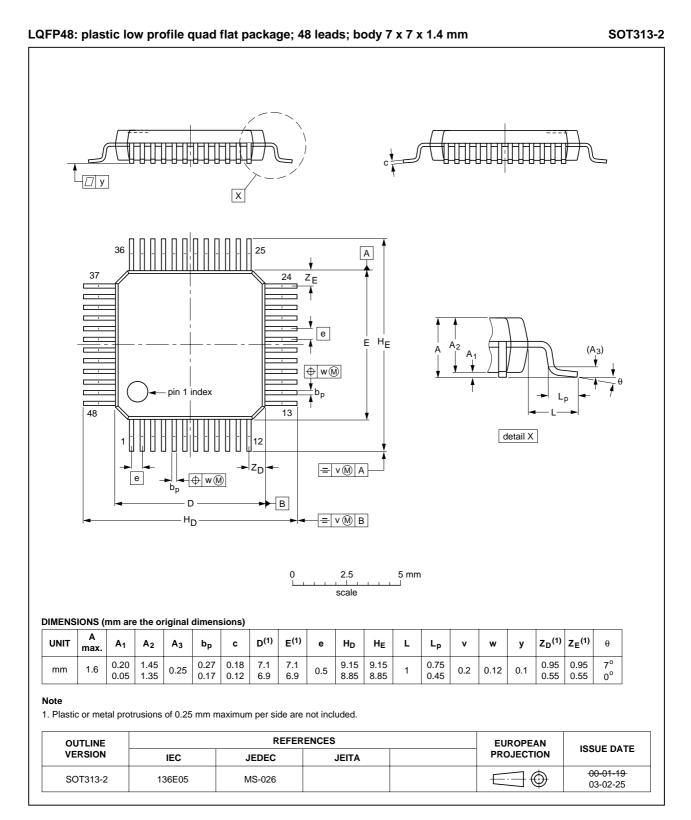
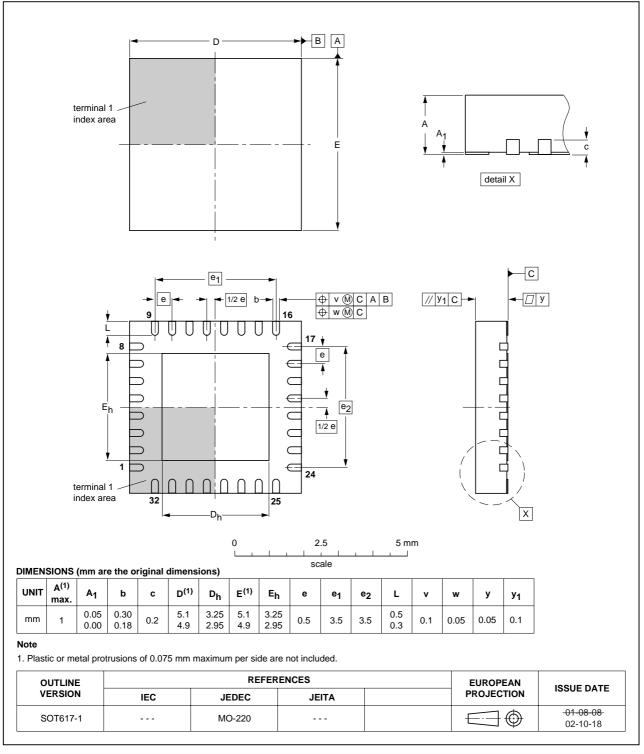


Fig 23. Package outline SOT313-2 (LQFP48)

5 V, 3.3 V and 2.5 V dual UART, 5 Mbit/s (max.), with 64-byte FIFOs



HVQFN32: plastic thermal enhanced very thin quad flat package; no leads; 32 terminals; body 5 x 5 x 0.85 mm

SOT617-1

Fig 24. Package outline SOT617-1 (HVQFN32)

13. Soldering

13.1 Introduction to soldering surface mount packages

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering can still be used for certain surface mount ICs, but it is not suitable for fine pitch SMDs. In these situations reflow soldering is recommended.

13.2 Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement. Driven by legislation and environmental forces the worldwide use of lead-free solder pastes is increasing.

Several methods exist for reflowing; for example, convection or convection/infrared heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 seconds and 200 seconds depending on heating method.

Typical reflow temperatures range from 215 °C to 260 °C depending on solder paste material. The peak top-surface temperature of the packages should be kept below:

Table 27.SnPb eutectic process - package peak reflow temperatures (from J-STD-020C
July 2004)

| Package thickness | Volume mm ³ < 350 | Volume $mm^3 \ge 350$ |
|-------------------|------------------------------|-----------------------|
| < 2.5 mm | 240 °C + 0/–5 °C | 225 °C + 0/–5 °C |
| ≥ 2.5 mm | 225 °C + 0/–5 °C | 225 °C + 0/–5 °C |

Table 28.Pb-free process - package peak reflow temperatures (from J-STD-020C July
2004)

| / | | | |
|-------------------|------------------------------|---------------------------------------|-------------------------------|
| Package thickness | Volume mm ³ < 350 | Volume mm ³ 350 to 2000 | Volume mm ³ > 2000 |
| < 1.6 mm | 260 °C + 0 °C | 260 °C + 0 °C | 260 °C + 0 °C |
| 1.6 mm to 2.5 mm | 260 °C + 0 °C | 250 °C + 0 °C | 245 °C + 0 °C |
| \geq 2.5 mm | 250 °C + 0 °C | 245 °C + 0 °C | 245 °C + 0 °C |

Moisture sensitivity precautions, as indicated on packing, must be respected at all times.

13.3 Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):

- larger than or equal to 1.27 mm, the footprint longitudinal axis is preferred to be parallel to the transport direction of the printed-circuit board;
- smaller than 1.27 mm, the footprint longitudinal axis **must** be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

• For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time of the leads in the wave ranges from 3 seconds to 4 seconds at 250 °C or 265 °C, depending on solder material applied, SnPb or Pb-free respectively.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

13.4 Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 $^{\circ}$ C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 seconds to 5 seconds between 270 $^\circ C$ and 320 $^\circ C.$

13.5 Package related soldering information

 Table 29.
 Suitability of surface mount IC packages for wave and reflow soldering methods

| Package ^[1] | Soldering method | |
|---|-----------------------------------|-----------------------|
| | Wave | Reflow ^[2] |
| BGA, HTSSONT ^[3] , LBGA, LFBGA, SQFP, SSOPT ^[3] , TFBGA, VFBGA, XSON | not suitable | suitable |
| DHVQFN, HBCC, HBGA, HLQFP, HSO, HSOP, HSQFP, HSSON, HTQFP, HTSSOP, HVQFN, HVSON, SMS | not suitable ^[4] | suitable |
| PLCC ^[5] , SO, SOJ | suitable | suitable |
| LQFP, QFP, TQFP | not recommended ^{[5][6]} | suitable |
| SSOP, TSSOP, VSO, VSSOP | not recommended ^[7] | suitable |
| CWQCCNL ^[8] , PMFP ^[9] , WQCCNL ^[8] | not suitable | not suitable |

 For more detailed information on the BGA packages refer to the (LF)BGA Application Note (AN01026); order a copy from your Philips Semiconductors sales office.

[2] All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods.

- [3] These transparent plastic packages are extremely sensitive to reflow soldering conditions and must on no account be processed through more than one soldering cycle or subjected to infrared reflow soldering with peak temperature exceeding 217 °C ± 10 °C measured in the atmosphere of the reflow oven. The package body peak temperature must be kept as low as possible.
- [4] These packages are not suitable for wave soldering. On versions with the heatsink on the bottom side, the solder cannot penetrate between the printed-circuit board and the heatsink. On versions with the heatsink on the top side, the solder might be deposited on the heatsink surface.
- [5] If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
- [6] Wave soldering is suitable for LQFP, QFP and TQFP packages with a pitch (e) larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
- [7] Wave soldering is suitable for SSOP, TSSOP, VSO and VSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.
- [8] Image sensor packages in principle should not be soldered. They are mounted in sockets or delivered pre-mounted on flex foil. However, the image sensor package can be mounted by the client on a flex foil by using a hot bar soldering process. The appropriate soldering profile can be provided on request.
- [9] Hot bar soldering or manual soldering is suitable for PMFP packages.

14. Abbreviations

| Table 30. | Abbreviations |
|-----------|---|
| Acronym | Description |
| CPU | Central Processing Unit |
| DMA | Direct Memory Access |
| FIFO | First In, First Out |
| UART | Universal Asynchronous Receiver/Transmitter |

15. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|---------------------------------|----------------------------------|---|---|---|
| SC16C752B_4 | 20060714 | Product data sheet | - | SC16C752B-03 |
| Modifications: | Section 2 "F | eatures": deleted (old) first l | oullet "Dual channel" | |
| | Table 2 "Pin | description": separated sign | nal symbols per pin numb | er |
| | Section 6.3. | 3 "Software flow control exa | mple": appended "h" to he | ex numbers |
| | • <u>Table 9</u> , <u>Tab</u> | le note 4: changed "xBF" to | "BFh" | |
| | Table 10 "So | C16C752B internal registers | | |
| | deleted of | descriptive line below table t | itle (is now Table note 2) | |
| | removed | shading from table cells | | |
| | | b-section "Enhanced Registed functions" to "enable IER[| | |
| | Table no | te 4: changed "BF _{Hex} " to "BF | ĥ" | |
| | Section 7.12 | : renamed register "DLH" to | "DLM" | |
| | • Table 24 "Li | miting values": removed Tab | le note 1 (it is now in <mark>Sec</mark> | tion 16.3 "Disclaimers") |
| | Table 25 "St | atic characteristics" | | |
| | title of ta | ble changed from "DC elect | rical characteristics" to "S | tatic characteristics" |
| | in heade | r row, changed "Nom" to "Ty | p" | |
| | | er "clock speed" and (old) ta as "f _{XTAL1} ") | ble note 7 removed from | this table (is presented in |
| | added "δ | " to symbol column of paran | neter "clock duty cycle" | |
| | added pa | arameter I _{CC(sleep)} , and Table | e note 8 | |
| | reordere | d table notes | | |
| | Table 26 "Dy | ynamic characteristics": | | |
| | title of ta | ble changed from "AC electi | ical characteristics" to "D | ynamic characteristics" |
| | | d units for t _{d10} , t _{d13} , t _{d15} , t _{d18} _{Ik} baud rate" to "s") | modified (appended "T _R | _{CLK} " to value; changed unit |
| | – symbol " | t _{p3} , clock speed" changed to | "f _{XTAL1} , frequency on pin | n XTAL1" |
| | changed | symbol "t _(RESET) " to "t _{w(RESE} | _{T)} " and added <u>Table note</u> | <u>93</u> |
| | | minimum values for t _{w(RESE} to "40 ns") | _{T)} (2.5 V: from "200 ns" to | o "100 ns"; 3.3 V/5 V: from |
| | deleted (old |) Figure 16 "Alternate read/ | vrite strobe timing" | |
| | • Figure 18, F | Figure 19, Figure 21, Figure | 22: changed "DATA BITS | (5-8)" to "data bits (0 to 7)" |
| | • Figure 22: c | hanged "BYTE #32" to "byte | #64" | |
| | Added Sect | ion 14 "Abbreviations" | | |
| C16C752B-03 9397 750 14443) | 20041214 | Product data | - | SC16C752B-02 |
| Iodifications: | AN10333 (F | modification to the data she Rev. 02) "SC16CXXXB baud eased together with this revi | rate deviation tolerance" | |
| SC16C752B-02 9397 750 13337) | 20040527 | Product data | - | SC16C752B-01 |
| C16C752B-01 | 20040326 | Product data | - | - |

(9397 750 11981)

16. Legal information

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| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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[2] The term 'short data sheet' is explained in section "Definitions".

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SC16C752B

5 V, 3.3 V and 2.5 V dual UART, 5 Mbit/s (max.), with 64-byte FIFOs

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Date of release: 17 July 2006 Document identifier: SC16C752B_4

